



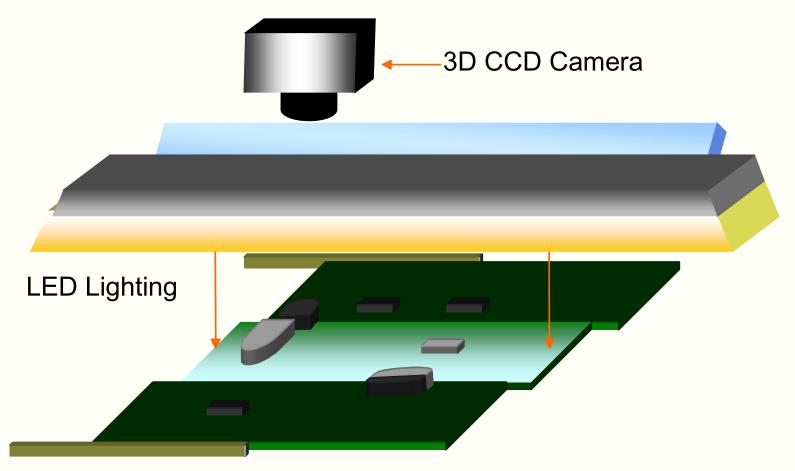
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# Single Line Scanning Technology

- Captures Entire PCB Image by High Speed
- > Full Memory Function to hold an entire PCB Image on screen

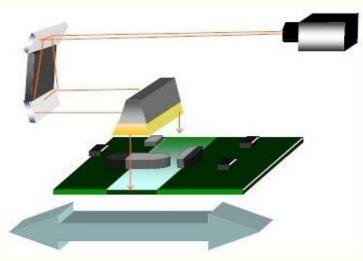


High Speed, Smooth Scanning, Still = Less Wear and Tear



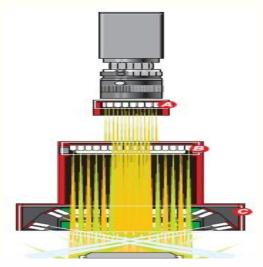
# Scanning Method-(1)

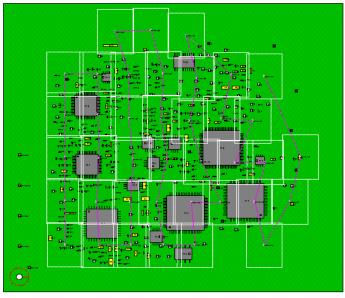
## Single Line Scanning





## vs. <u>Multi field of view Scanning</u>



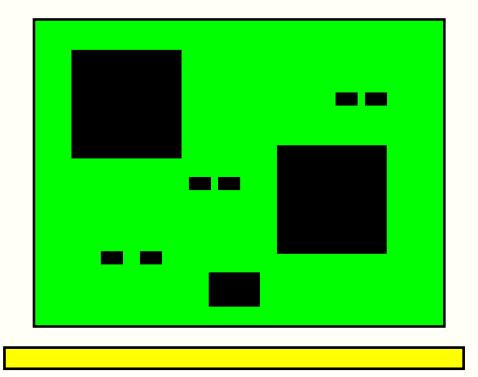




# Scanning Method-(2)

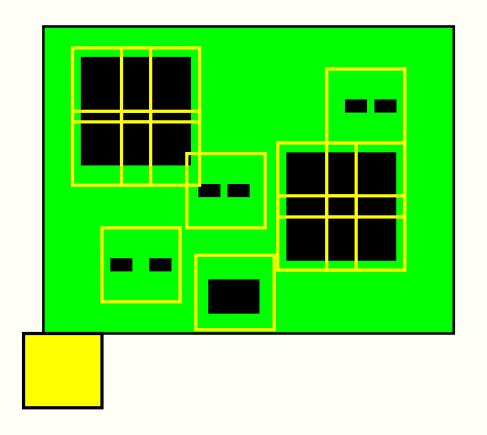
**Inspection completed** 

Line scanning



Inspection completed

Field of View Scanning



- > Faster inspection Tact time
- Easy to add inspection data at design change

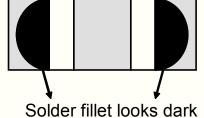


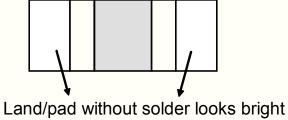
## Basic Inspection Method

Go/No-go judgment will be made by giving numerical value to each pixel's brightness on scanned image.

→ Brightness Level = 255-0

# Example: Solder Inspection (Black/White) Light will be refracted against the slope. NG Light will be thrown back to above against flat area.







# Coaxial TOP Light

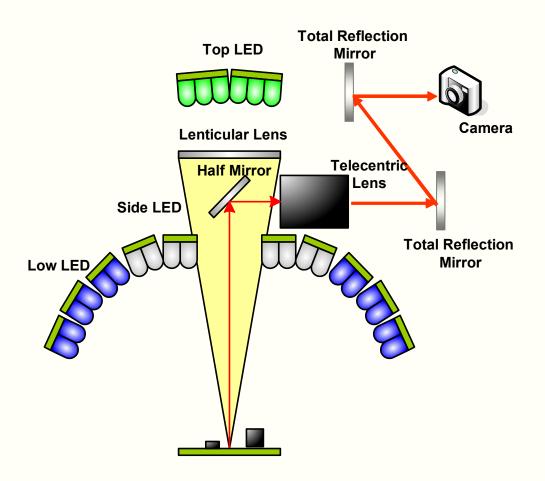
## Saki products realize an inspection using a complete overhead lighting.

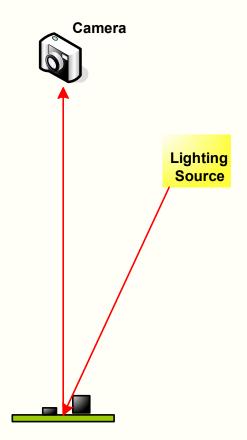
## **Coaxial Overhead Light**

Saki's overhead TOP light will not throw a shadow over component (s).

## **Conventional Lighting Method**

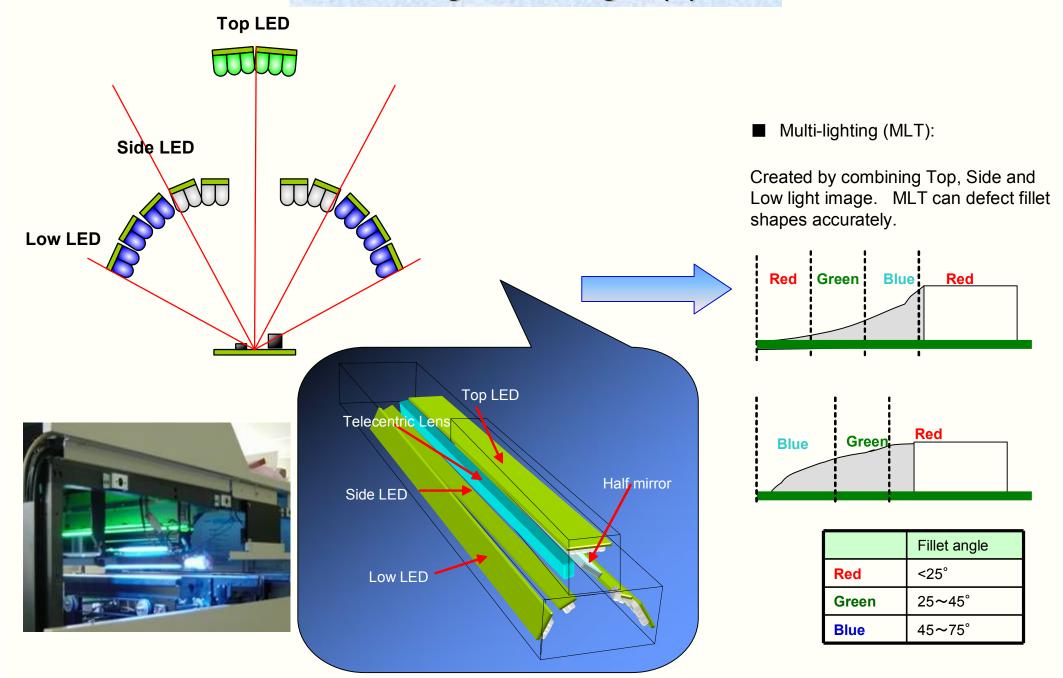
Parts next to taller components are shaded by the lighting. Inspection data needs to be adjusted.







# 3-stage LED Light (1)





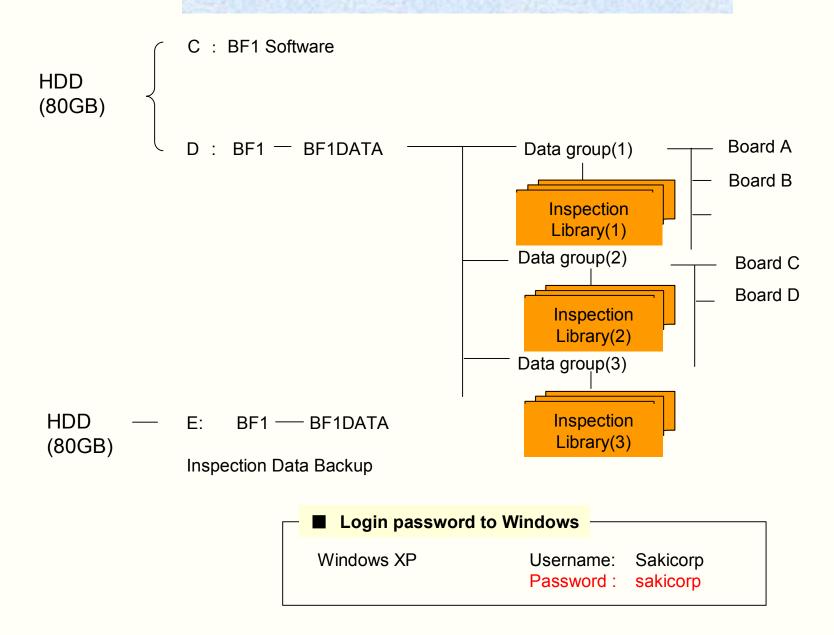
# 3-stage LED Light (2)

	Top Light	Side Light	Low Light	MLT Light
		ROS TOALS	ROS	Res
Features	- Effective for solder and polarity inspections - Convex & concave sensitive - Monochrome screen (detect dark/bright contrast) - Inspect tall components (no effect by adjacent components)	- Full color display - Color inspection (for Missing, red-eye inspection) - Image nearest to the human eye sight	- Can extract an image that has high level of visibility - OCR recognition - Reduce shiny flux's influence (= Effective for bridge inspection)	- Combine Top, Side, and Low light images - Solder fillet inspection, lifted lead inspection

Approximately 20 different lightings are available today, by adjusting Top, Side, and Low lights flexibly by software.



## Data/Folder Structure





# Contents: Inspection data making

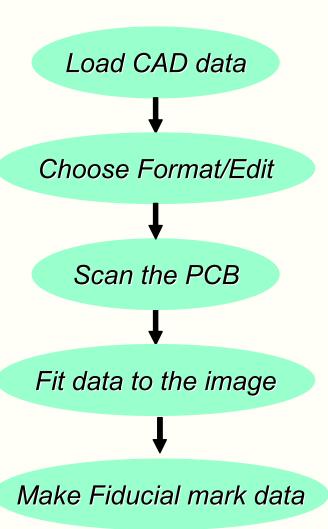
Importing CAD data	.P12-25
Fiducial marks	.P26-31
Inspection data making	
Typical inspection for chip components	P32-41
Typical inspection for QFP / SOP	.P42-51
Debug operation	.P52



- CAD data
  - ✓ Text data / CSV file

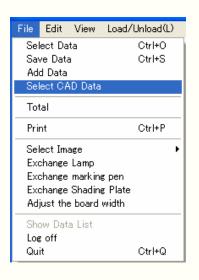
Cautions) Delete unnecessary text and empty boxes/lines

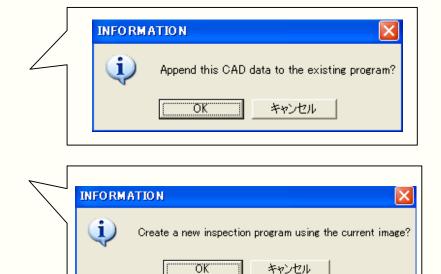
- X coordinate
- Y coordinate
- Angle ( $\theta$ )
- Component name (=Reference)
- Reel No (=Macro)
- Library (Optional)
   When library does not exist in CAD data,
   Reel No can be used instead.
- NC data / Mount data





#### 1) Choose "Select CAD Data" in the file menu





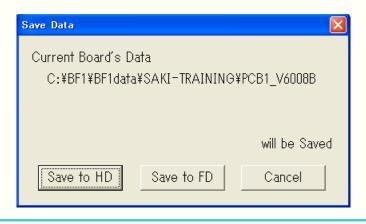
Choose cancel when you want to just open a new CAD data

#### [Cautions!]

Please choose OK when you have several NC data to make a PCB inspection recipe or double-side data.

%This message will show up When there is an image on the screen.Select either OK or Cancel.

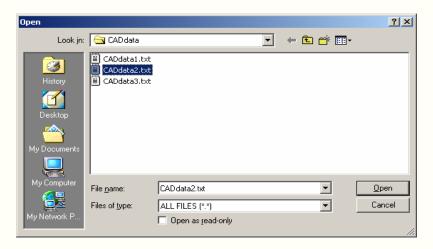
#### "Save to HD"



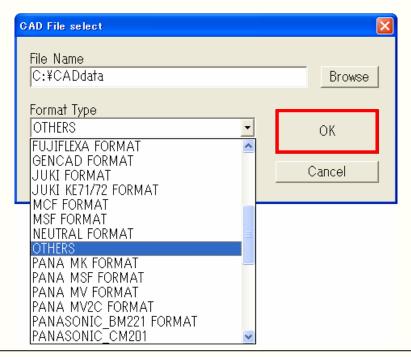
"Save to HD" if necessary.



#### 2) Select the file



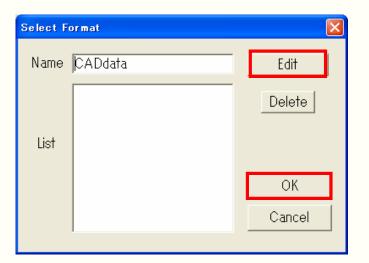
#### 3) Select "OTHERS" for CAD text format and choose OK



※ Select appropriate data format for NC data.



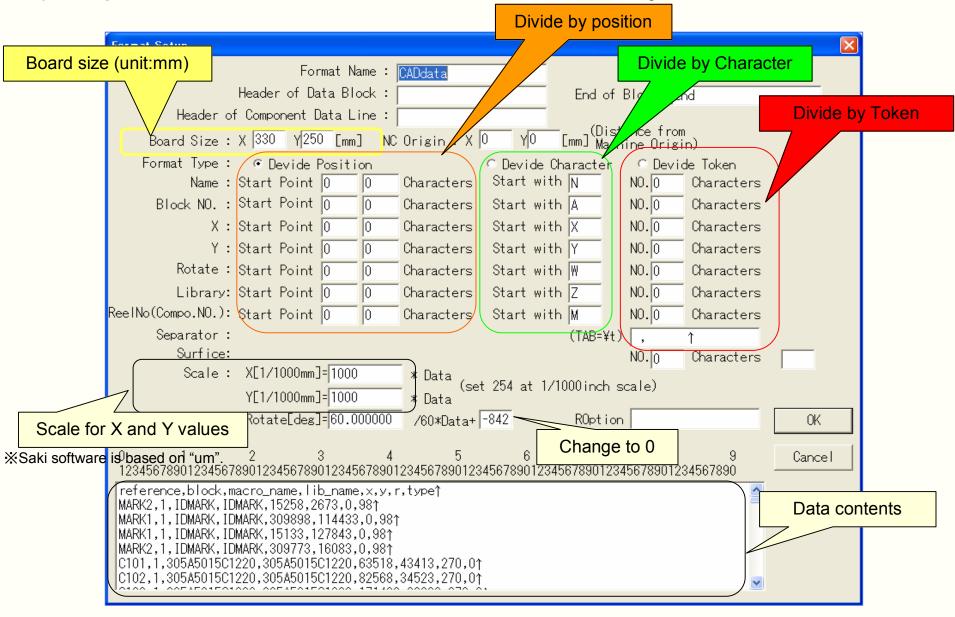
## 4) Input the name of the format to be defined, and Click Edit



Type in the name of the format when importing a new data. In case there is an existing format, choose appropriate format.

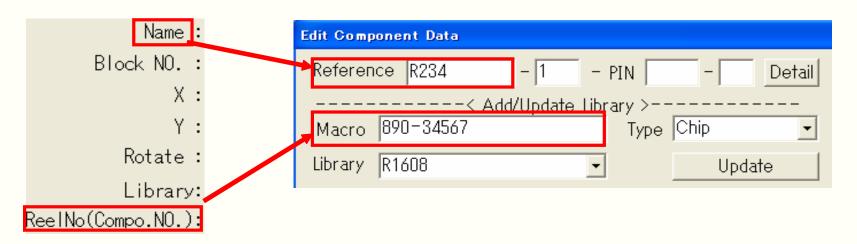


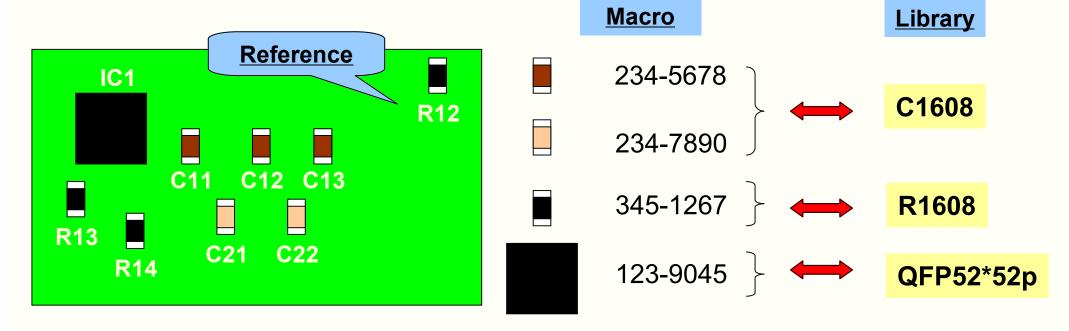
5) Set up the format to read the CAD data in one of the three ways.





## ■ Reference, Macro & Library



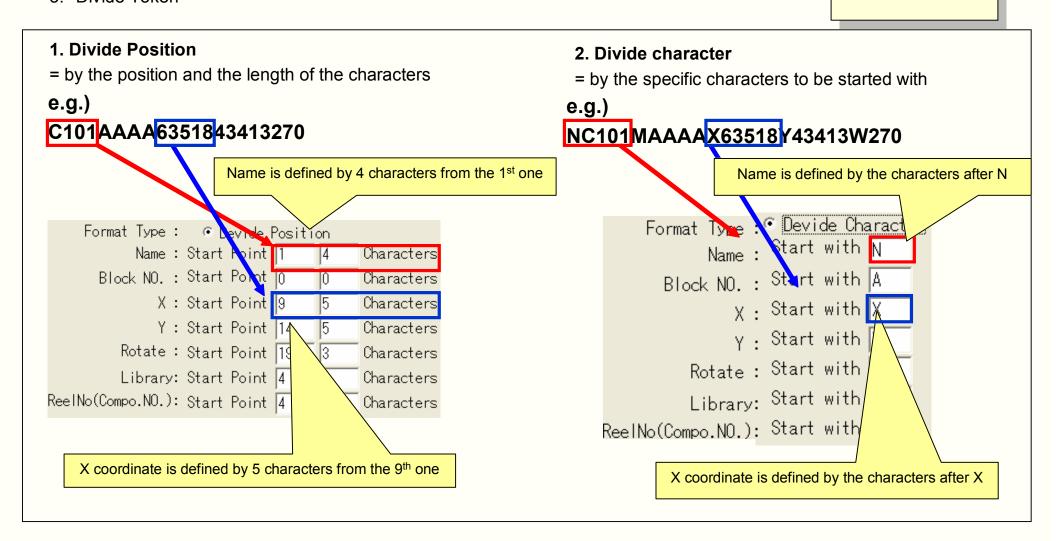




#### Three Choices to define the reading format:

- 1. Divide Position
- 2. Divide Character
- 3. Divide Token

Name: C101 X: 63518 Y: 43413 Rotate: 270 Reel No: AAAA

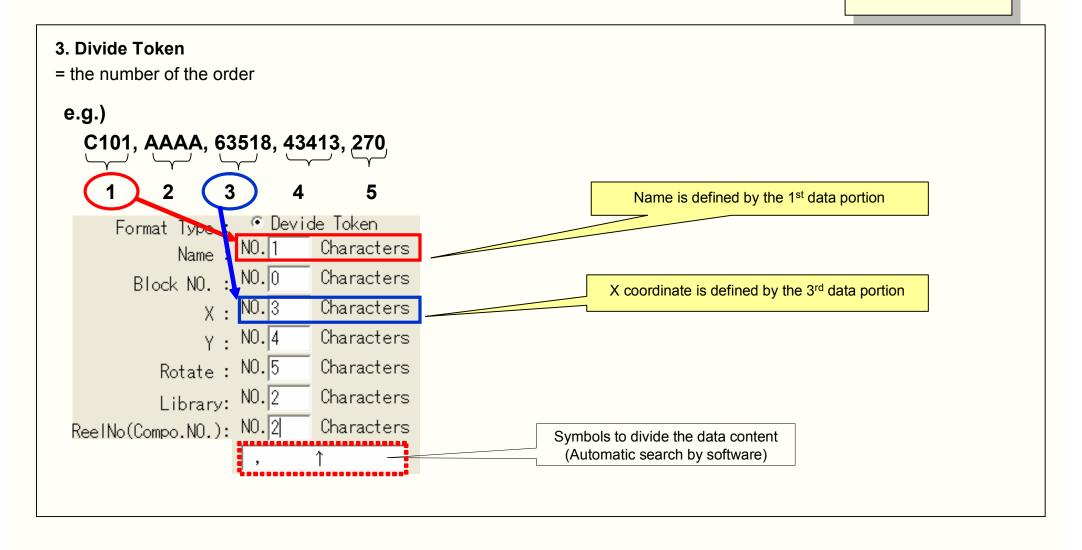




#### Three Choices to define the reading format:

- 1. Divide Position
- 2. Divide Character
- 3. Divide Token

Name: C101 X: 63518 Y: 43413 Rotate: 270 Reel No: AAAA

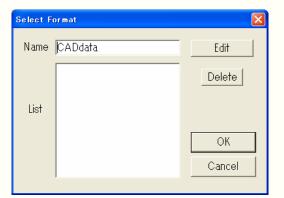




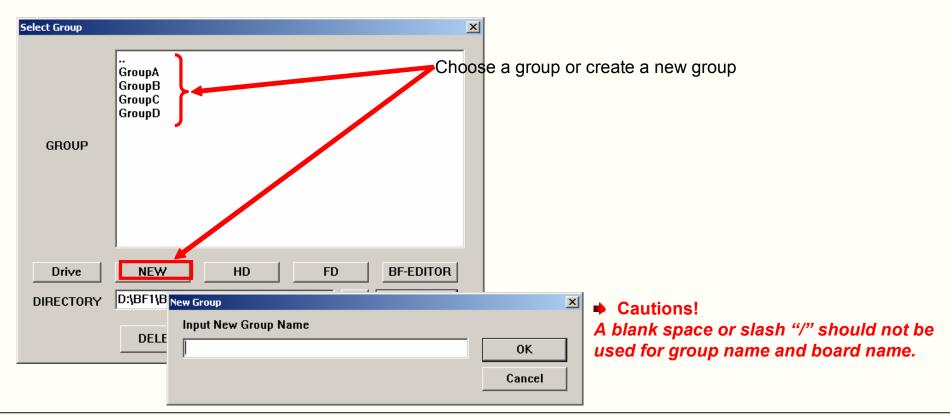
20

# Importing CAD data

## 6) Choose or Create a group to put the data into



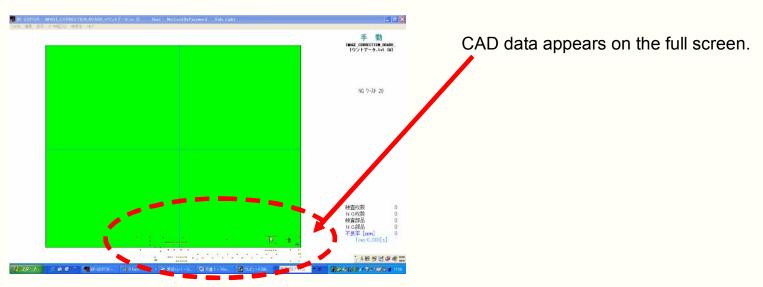
Going back to the previous Select Format dialog, Click OK after confirming the appropriate format is selected.

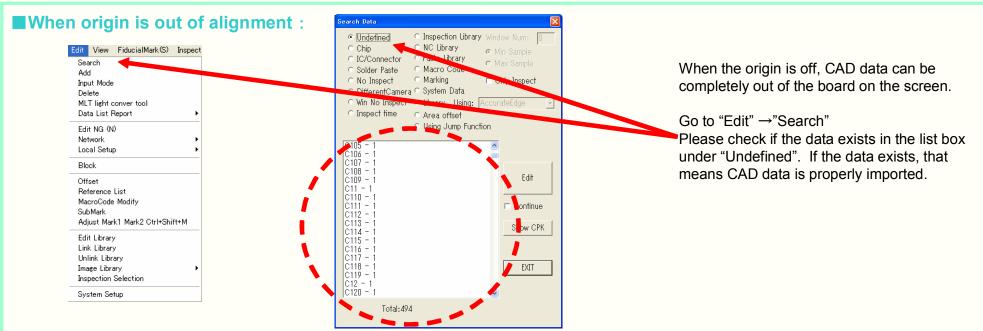






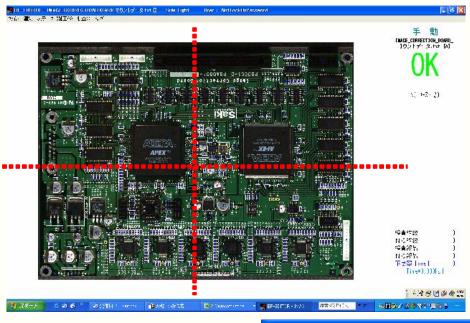
## 7) Confirm if the CAD data is properly imported







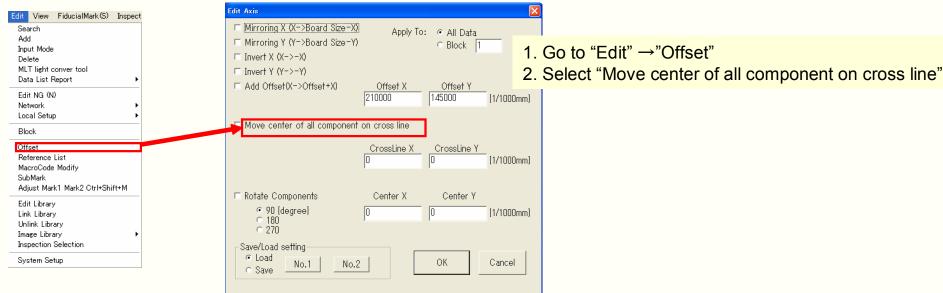
## 8) Scan the image and fit the window position



Click the center of the board image and move a white cross line to the center.

#### [Screen operation]

- The image can be enlarged by click.
- Click at right-hand index area to go back to a full screen.

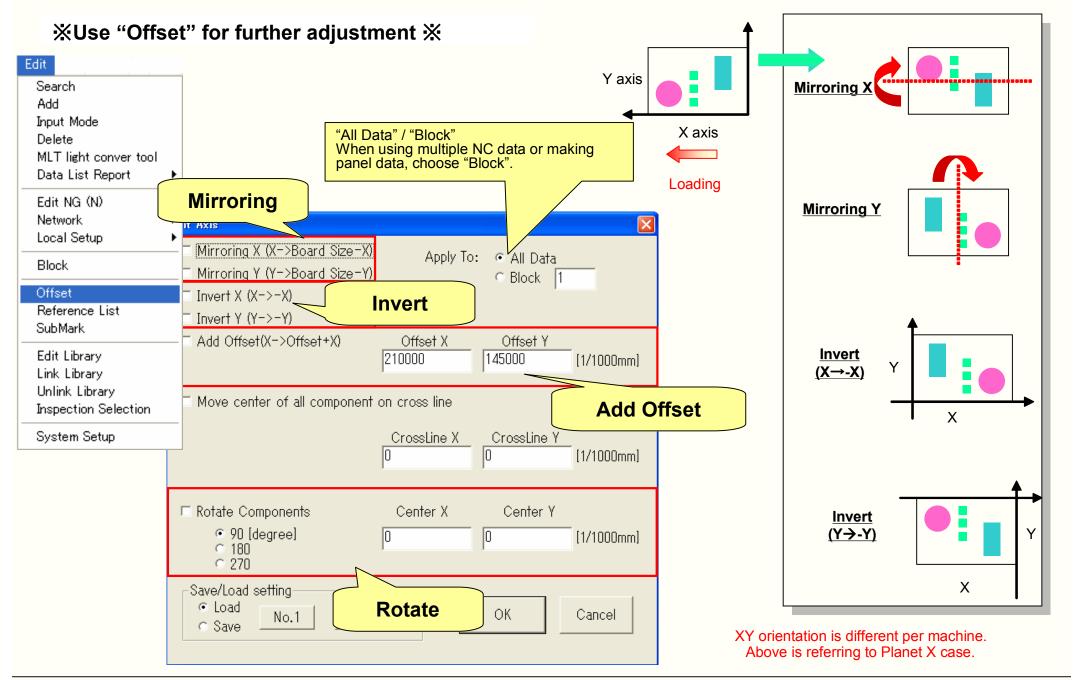




\* Use "Display ID name to show the components' name 9) Scan the image and fit the window positions Load/Unload(L) Scan(S) ✓ Layout Mode
 Total Mode Area offset display Whole Map Enlarge Composed Color 2032 Component Body → Display ID Name Rename Component C6 [[] C6 👫 ✓ Side A Side B Results Select Total Display Ctrl+D Image Plane (D) Memory Ctrl+X Move Component C31 - 1will be Moved -2834 [1/1000mm] Distance 5977 [1/1000mm] Move Current Component Current Block C All Data Drag and drop the window All Data with Fiducial Mark Data Current Machine Number \* Open CAD data by right click at the center and Put some inspection item in a window to be able to drag OK

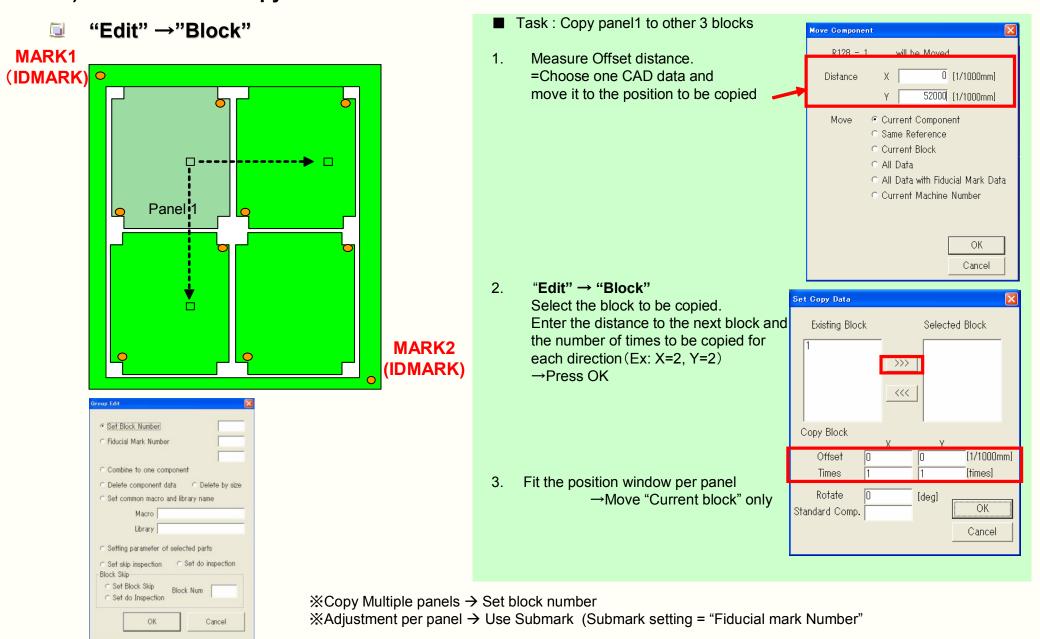
Cancel







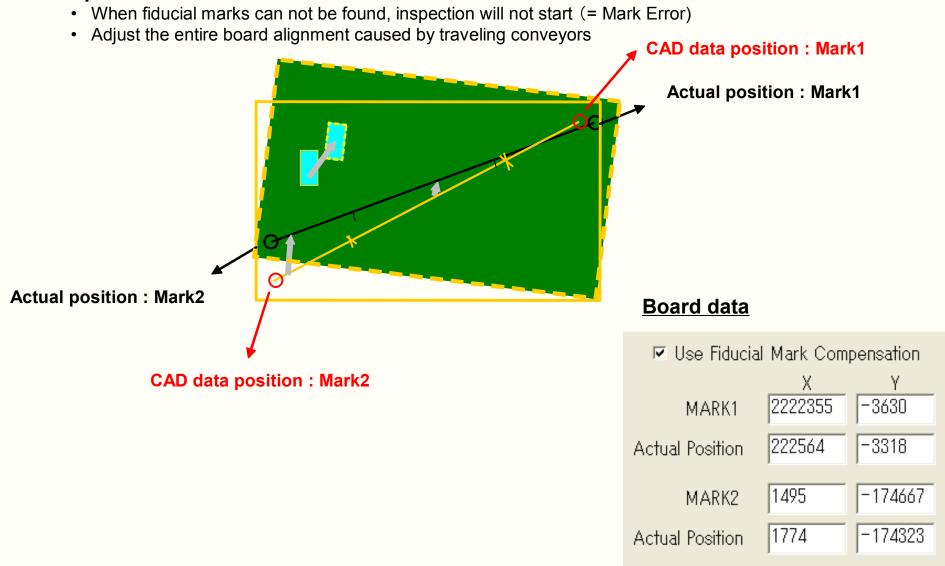
## 10) Use "Block" to copy the CAD data to other blocks





#### Fiducial Mark adjustment

#### Purpose





# Data Edit Diglog

#### 3 Main Boxes

**Reference** = "Name" – "Panel #" – "Pin #" – "inspection item # per pin"

**Macro** = Reel No. / Component spec

**Library** = inspection library name



A series of inspection data for each components, which can be applied to all same components based on Reel No.

#### **Key Select Item**

Type: Chip, IC/connector, Fudicial mark Normal Next

**Kind**: Area, Adjust, missing, Reverse...

**Lighting:** Toplight, Side light,....

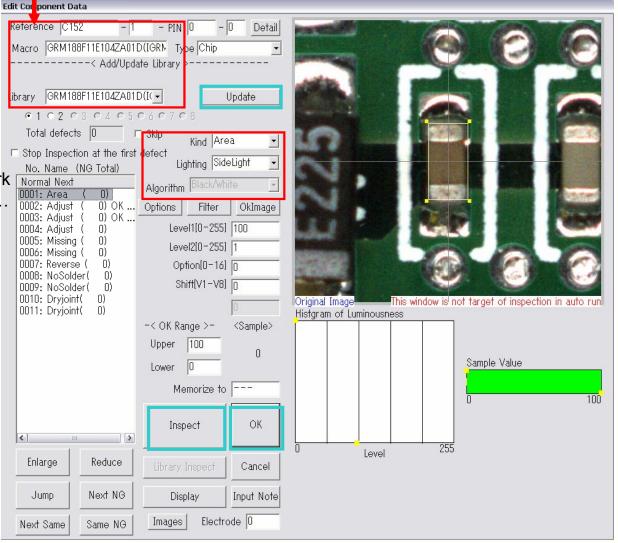
Algorithm: .....

#### 3 STEPS

[Inspect] Update inspection data

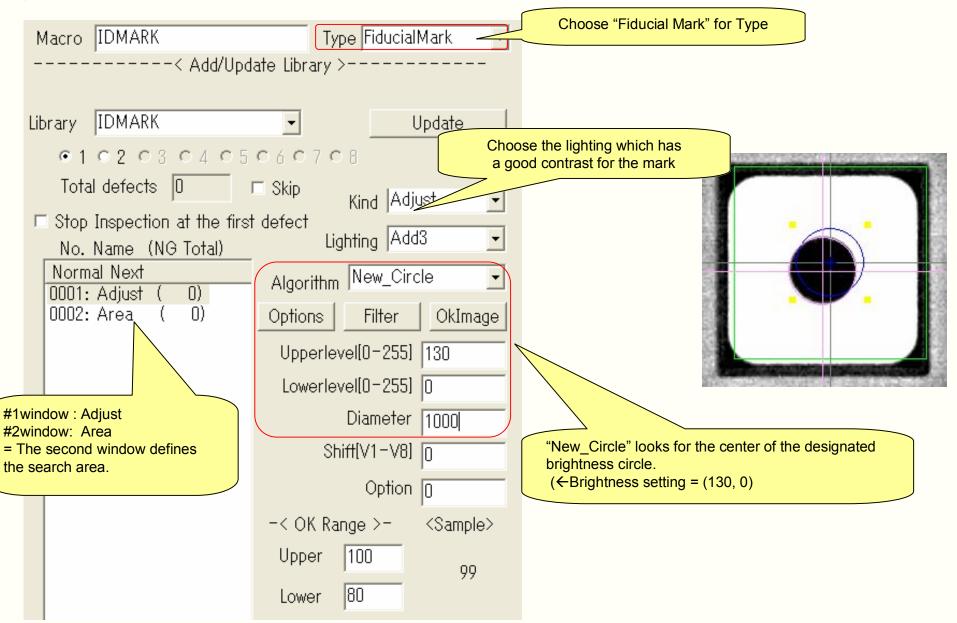
[Update] Update library

[OK] Close edit dialog





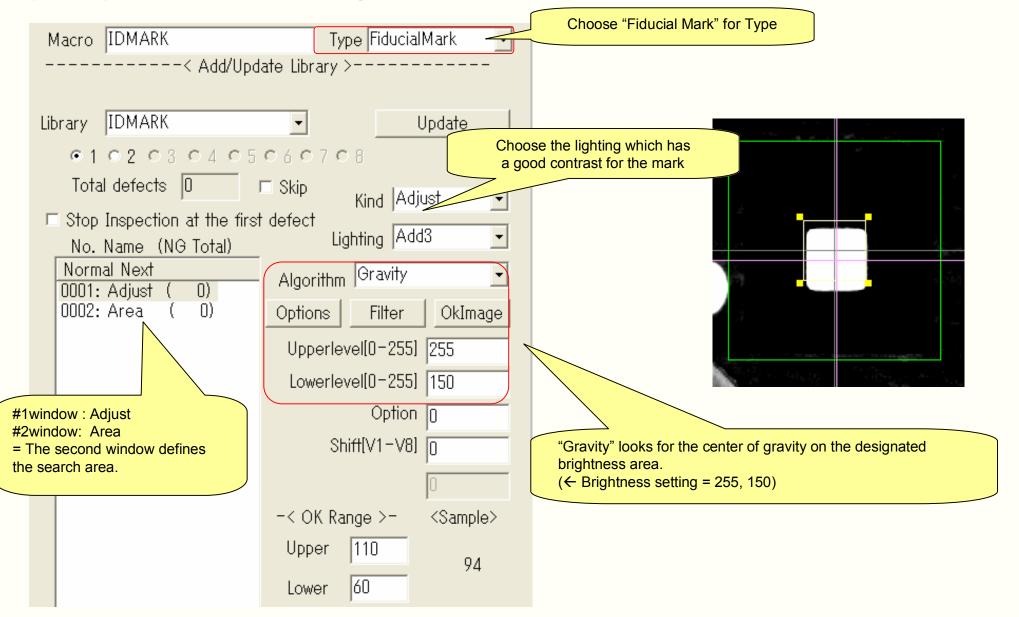
## 1)-1: Circular Mark ● → "New Circle"



28



## 1)-2: Square mark ■ → "Gravity"

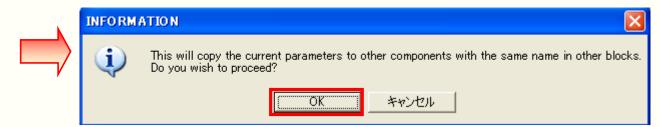




#### 2) Update Fiducial marks coordinate

- Press "Inspect" → Confirm if pink cross line is located at the center of fiducial marks
- Press "Update" → To update the fiducial mark library data





■ Press "OK" to update fiducial mark coordinate.

## **Important**



- 1. Move the location?
- CAD has fiducial marks → Cancel
- CAD has no fiducial marks→OK



2. Update Fiducial mark coordinate

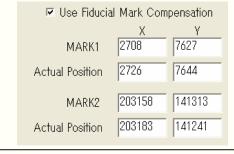
→OK



- 3. Register the fidicial mark reference position?
- CAD has fiducial marks →OK
- CAD has no fiduail marks →Cancel

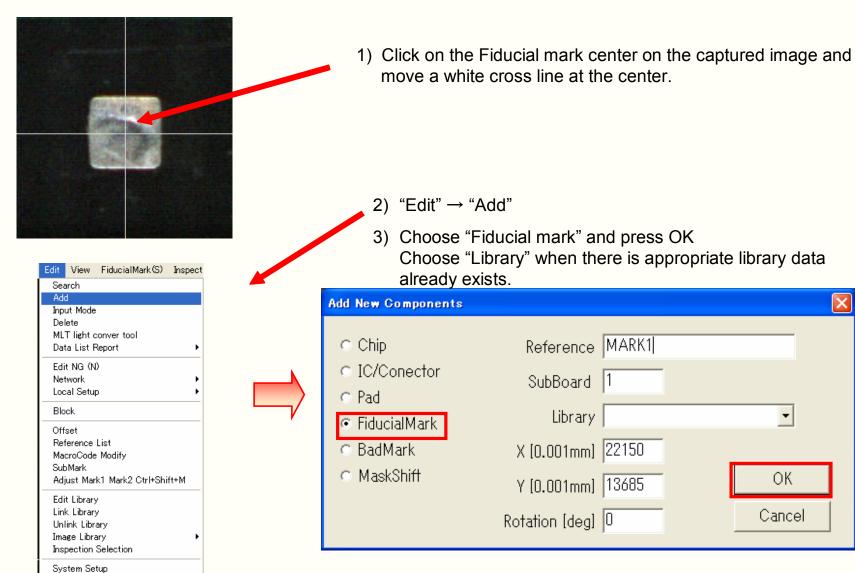
Check point

Check to confirm fuducial marks coordinates are properly entered on the board data





#### ■ When CAD data does not have Fiducial mark coordinate;



"Edit dialog" will appear to make library data.

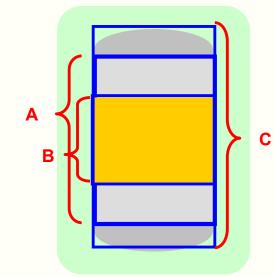


# Chip components Inspections

•	Average	.P34
•	Color XY	.P35
•	Color-Channel	.P36
•	Black / White	.P37
•	New ASC	.P38
•	L/W tracking	.P39
•	ChipMissing3/Chip	P40
•	Color L/W tracking	.P41



## **Automatic Data generation for Chip Components**



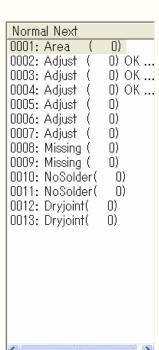
#### By setting 3 windows, a standard Chip inspection data can be generated.

Window A = Select the body including the electrodes

Window B = Select the body without the electrodes

Window C = Enlarge the window to include the pads

Select "Chip" as Type and the following window will be displayed.





Select algorithm for "Adjust"
(New ASC or L/W Tracking)

Click "OK" to generates a series of inspection windows.



#### **Average**

#### **Brightness average value within the window**



#### **Example**

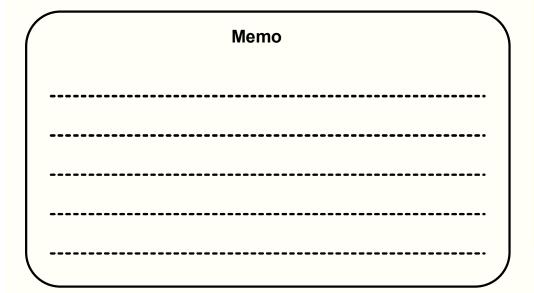
Reverse check of resistance chip.

When the chip is reversed, a backside of the component is white, (Sample value : above 150 = NG)

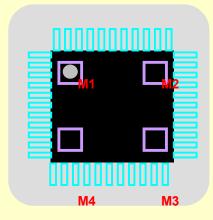
NG type Reverse
Lighting Optional
Shift [V1-V8] V3
<OK Range>
Upper 150

0

Lower



#### **Application: Polarity Inspection**



#### Example

NG Type Polarity
Lighting Optional
Algorithm Average +

Memory1 – Memory2

#### ■ Procedures (For QFP)

- 1. Put inspection window on polarity mark (Use circle window by "option" button as necessary)
- 2. Select "Polarity", appropriate Lighting and "Average"
- 3. Put V1 or V3 at "Shift" box
- 4. Register the data as "M1"

→Memorize to: M1

#### Point1:

This window is to register numeric values, not to inspect.

Therefore, set "OK range" as below.

Upper: (255) Lower: 0

- 5. Register M2, M3, M4 by copying M1 window.
- 6. Using Algorithm "M1-M2" to calculates the following:

M1-M3

M1-M4

#### Point2

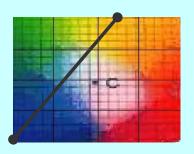
Sample value should be constantly either plus or minus value. Set OK range accordingly.

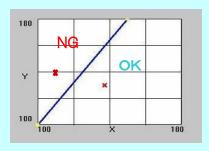
Plus →	Minus→	
Upper: (255 )	(-1)	
Lower: \ 1	(-1 -255)	



## **Color XY**

#### Judge OK/NG based on color average





Example

NG Type Missing Lighting Side

#### Point

Sample value = Distance from blue sample border

A Judgment is made based on whether mapping dot is located on upper or lower of the sample border.

Set "OK range" using "Plus" are "Minus" value divided by the sample border.

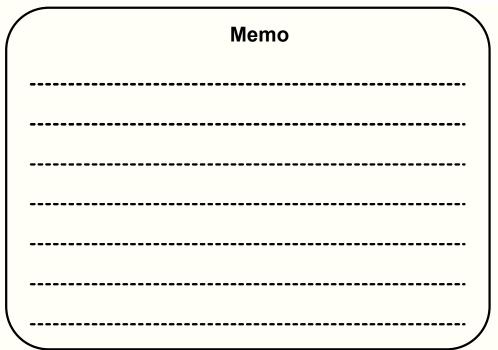
Upper Lower  $\begin{pmatrix} 255 \\ 0 \end{pmatrix}$ 

or

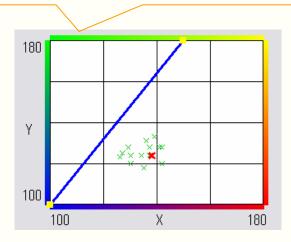
0 -255



e.g.: When a component is missing, PCB surface resist will come into the inspection window. Color mapping location will get to green area in case of NG whereas it is supposed to locate towards yellow/red boundary.



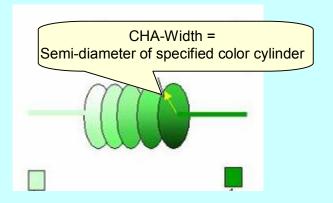
Same library components' mapping are displayed by green as a reference.





## **Color Channel**

Judge OK/NG by % of the specified color, by extracting 2 colors in 3D space of RGB



#### Example

NG Type Missing Lighting Side Shift [V1-V8] V3

CHA-Width 30 (= default)

<OK Range>

Upper 30 By adjusting CHA-Width value upward, machine will inspect based on wider range per extracted color.

Lower 0 range per extracted color.

2 colors can be extracted by "Ctrl+click" and "Alt+click"

#### Point

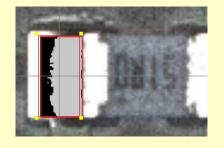
Color XY is the approach to capture a rough color pattern and average, while Color Channel is to conduct color inspection based on specified color.

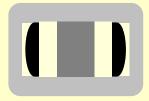
	Memo
\	



#### **Black/White**

Judge OK/NG based on occupied % of the specified range of brightness within the window





#### **Example**

NG Type No Solder

**Lighting** Top light in case of solder inspection

(Optional for other inspections)

<Specified brightness>

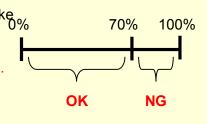
Level1 100 100 0

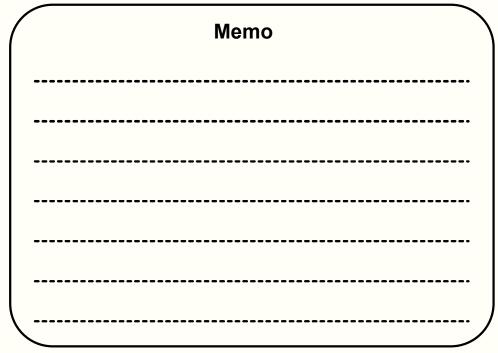
<OK Range>

Upper 100 (%)
Lower 70

#### Point

Setting the black / white algorithm is like cutting the world into two; bright and dark. Therefore, either Level1 or 2 should be always have either 255 or 0. For OK Range, either Upper or Lower should always have either 100 or 0.

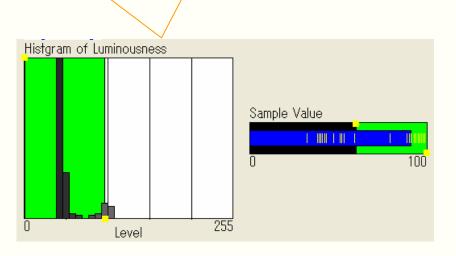




-Distribution of brightness value within the window

-Level1-Level2 range can be adjusted on the graph

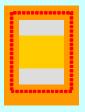
(Caution! Level1 should be always bigger than Level2)
-Use "Display" to see the gray area counted in the sample %



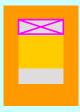


Auto-search based on bright area. Shift amount are quantifiable based on X, Y, and  $\theta$ .

**2** Terminal components

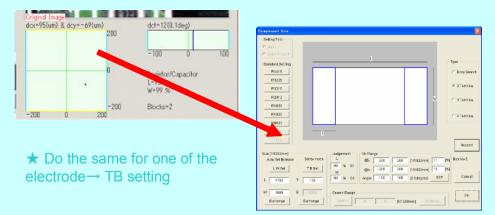






- 1. Set a 1.2-times-bigger window on subject component
- 2. Click "Mask" and cover entire body.

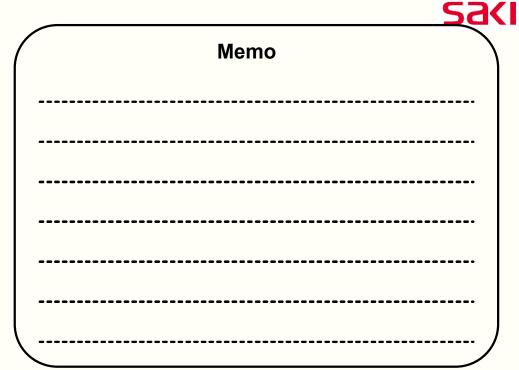
  By double clicking "Using Mask", mask window becomes editable. (="Editing Mask")
- 3. Right-click on green cross down below and measure the size for entire body. (= LW setting).

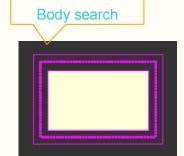


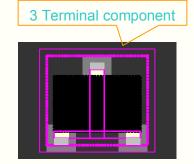
4. Remove Mask by clicking "Mask" and Inspect \* Inspection should be done without Mask.

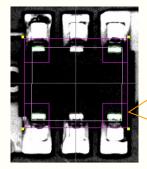
Pink window will show up when the search is successful.

- 5. Memorize shift value as V1.
- Valid for "Shift" inspection other Position "Adjust".
- In case that adjust can't be done well, check by "**Display**" button to fine-tune the specified luminance.









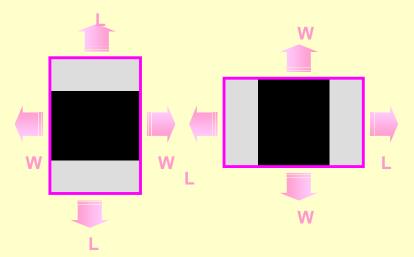
4 Terminal component
Measure the lead' shoulders

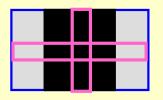
Caution:

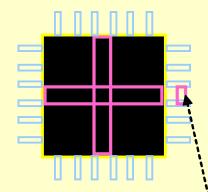
Search range needs to be set for 4 terminal components.



#### Adjust components' location by brightness V1 + V2 = V3



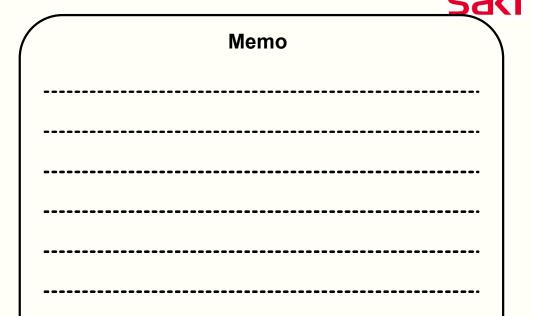




Be careful to select L or W.

Against the inspection window,

if the direction to be compensated is the longer direction, you should select "L", if the direction is shorter, you should select "W".



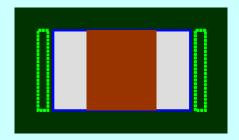
#### **Points**

- 1. The window needs to be set to catches the bright/dark edge.
- 2. Brightness setting  $\begin{pmatrix} 255 \\ 255 \end{pmatrix}$  or  $\begin{pmatrix} 0 \\ 0 \end{pmatrix}$
- \* Set based on whether the search components is darker or brighter than the peripheral area.
- 3. #001 window becomes the center of the following #002 and #003 windows. They should have the same center coordinate.
- \* By right-clicking on the inspection list, the center alignment can be checked.
- → When it is widely off, go back to the #001 window and review the position.

<sup>\*</sup> However, when it's difficult to set the windows right for large ICs, windows can be arranged on leads as an exception.

#### **Chip Missing3/ Chip**

Missing inspection for chip based on solder condition



#### Example

**Kind** Missing

**Lighting** Side (Fixed)

**PAD Side Max** Max of the brightness range by SIDE

PAD Top Max Max of the brightness range by TOP

Search(0-30) Search range

**Shift [V1-V8]** V1~V3

PAD Length  $40 \sim 50$ 

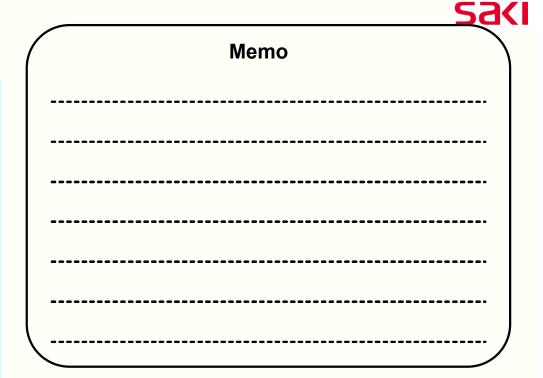
<OK Range>

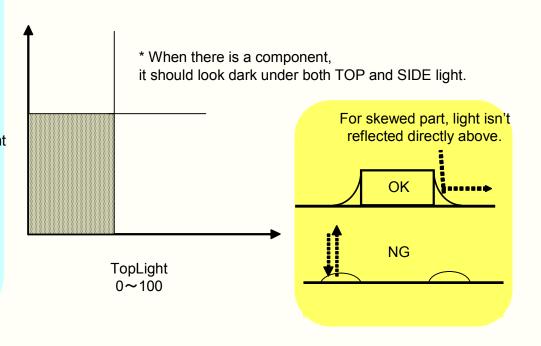
Upper 100

Lower 40

SideLight 0~140

\* "ChipMissing3" makes a judgment using the worse value of the leftand-right, or up-and-down inspection Windows, while "Chip" makes a judgment using the average of both sides.

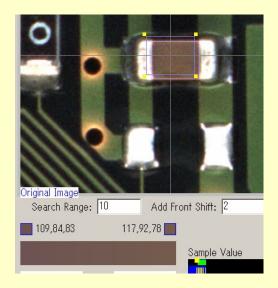






#### **Color L/W Tracking**

#### Search the component using the specified color



Extract colors by clicking two points, using Ctrl+Click, Alt+Click.

#### Example

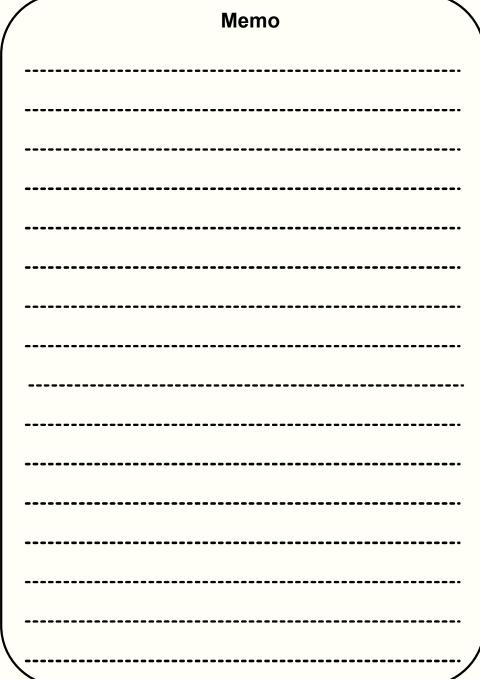
Kind Adjust Lighting Side

<OK range>

**Upper** (10) **Lower** (-10)

Search Range 10

- Two Set-up points :
- (1) Search Range
  Be sure to set the same values in the OK Range (+/-).
- (2) Add Front Shift / Area Ratio
  0/1 (one direction), 2(two directions)





## Typical inspection for QFP / SOP

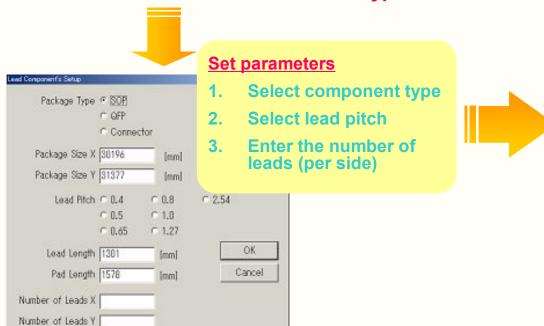
•	Max/Min	P45
•	Range/Peak	P46
•	New OCR	P47
•	ImageMatchEX	P48
•	LiftedLead	P49
•	Distribution	P50
•	ASpinsolder/pinsolder	P51
•	ASleadlength	P51



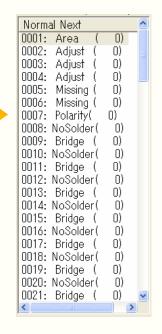
### **Auto Programming for QFP/SOP**

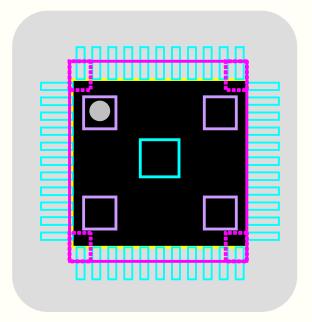


#### Select "IC/Connector" as Type



#### **Auto-generation of inspection windows**







## Tips for Editing data:

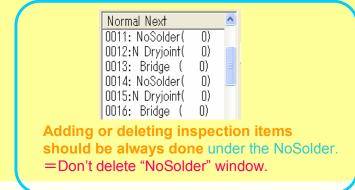
Inspection library 

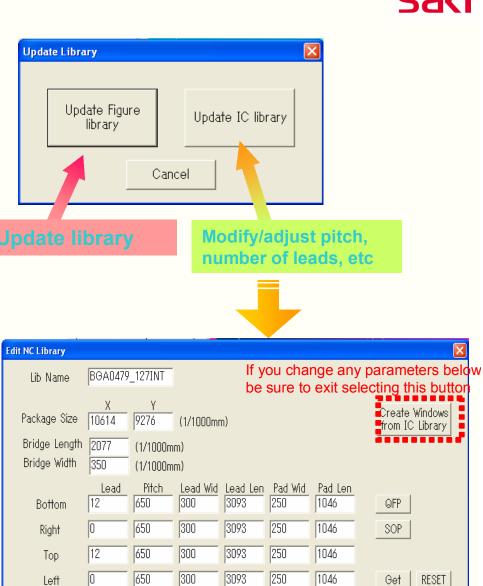
Figure Library

IC Library → Only for IC/Connectors

#### **Edit Examples:**

- When changing the **size of window**, all windows under same "kinds" of same line are adjusted at the same time.
- "Jump" can move to the pins at corners. (=location adjustment)
- "Next Same" can check pins one by one.
- "Next NG" can lead to all existing NGs one by one.
- Parameters can be modified at any pin. Then, select **parameter copy** (P-Copy) to adjust other pins parameters to the same.
- Select the first window edited and select "Copy lead settings to other" to copy the same window setting to other pins.





(1/1000mm)

Level2

80

Option

Max

60

40

Min

Lighting Algolithm Level1

TopLight LiftedLea 90

SideLight Distributi 0

TopLight Black/Wh 128

Solder

Bridge

DryJoint

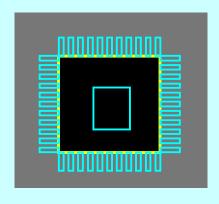
OK

Cancel

## sacı

#### Max / Min

#### **Check Max/ Min brightness value within the window**



**Example** 

Kind Foreign object

**Lighting** Optional

Averaging X [dot] 2

Averaging Y [dot] 2

<OK Range>

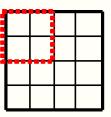
Upper 50

Lower 0



Memo

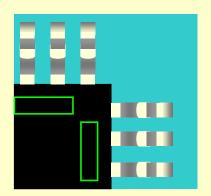
Averaging X=2
Averaging Y=2
Software considers 2x2=4 pixels as one unit.





#### Range

#### Calculate "Max – Min" within the window



Put windows at corners.

Then, when the component is shifted, brihg lead area will come into the window, resulting to raise sample value significantly.

#### Inspection example

Kind

Shift

Lighting

**Optional** 

Averaging X [dot] 2

Averaging Y [dot] 2

<OK Range>

Upper

50

Lower 0

\*Use X/Y copy to make the same window on the four sides.

"P copy" can be used to copy the parameter for the same "Kind".

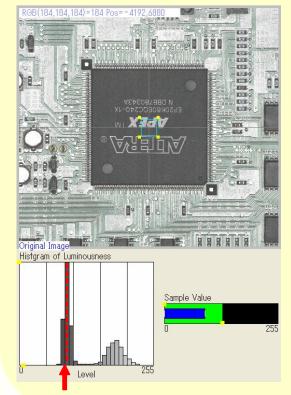


Application:

When resistance chip has a clear print on the surface, Range can be one of the approach for missing inspection.

#### **Peak**

#### Peak value of brightness within the window



Example

Kind: Missing

On the component, sample is 108. Resist will come into the window, which makes the samples of 205.

-< OK Range >-	<sample></sample>
Upper 120	108
Lower 0	100

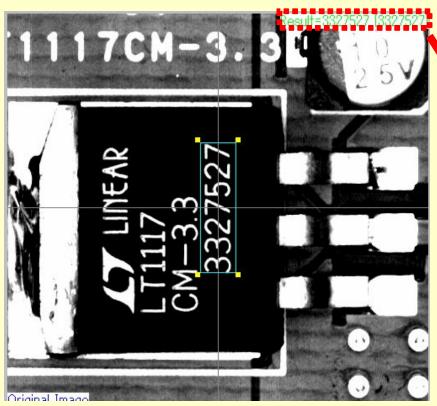
Memo	•



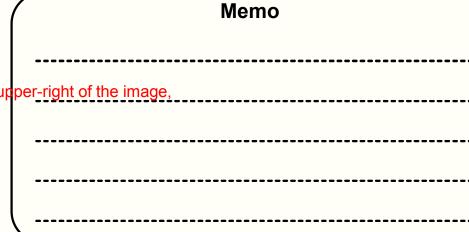
#### **New OCR**

#### **OCR** recognition algorithm

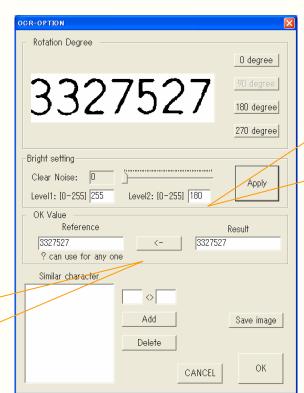
Right click the characters in the upper-right of the image, to go to the edit screen



- -Result "→" Reference
- Also possible to set similar characters that are easy to recognize wrong



Adjust by rotating so that it can be read from the front



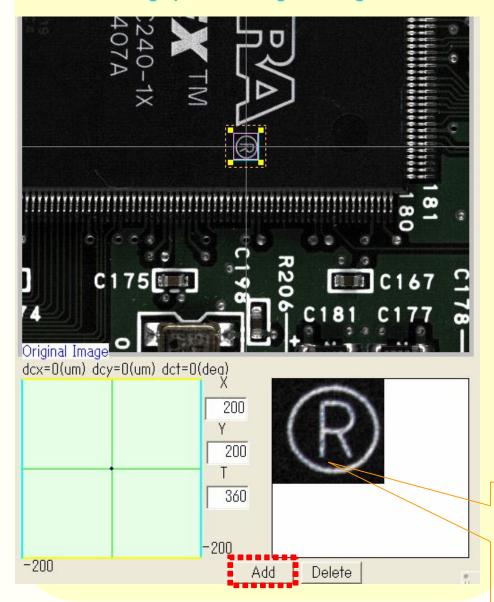
- Angle adjustment
- •Noise setting: Pulling to the right can reduce the noise.
- Brightness setting: Search for the characters based on the specified Level1-Level2. (Ex: 255-200)

<Caution>Don't forget to put shift (Ex. V1, V3).



#### **ImageMatchEX**

#### Image pattern recognition algorithm



	Memo
-	
-	
_	
•	
•	

□ Skip defect	Kind Miss	
Lig	inting LowL	ight 🔽
Algorithm   ImageMatchEx		
Options	Filter	OkImage
SearchRangeX 10		
SearchRangeY 10		
Method[1/2/3] 1		
Shiff[V1-V8] V3		
Resolution 1		
-< OK Range >- <sample></sample>		
Upper	100	99
Lower	60	/1

- Mouse-select the pattern to be recognized then press "Add" to capture its image
- Specify the Search Range (range shown by dotted line) using X and Y.
- ImageMatchEX is also effective for shift inspection, by setting XY for OK range area in the green map.

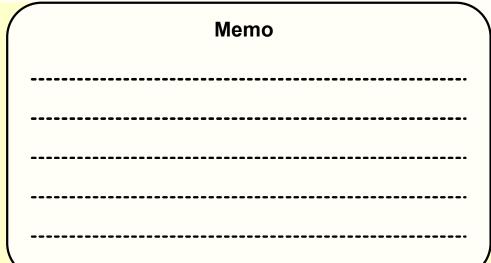
<Caution>ImageMatchEX and NewOCR is comparatively time-consuming. !



#### Liftedlead

Black/white at 2 points = Lead tip and the pad edge







Point

Make sure to put V3 or V1 to "Shift". Location adjustment is important to avoid false calls.

Step1:Black/white at the lead tip

0-30% = Since there is no/little bright area, OK→ Inspection completed!

30-60% = Unclear inspection result → go to Pad inspection

60-100% = Since solder does not exist, NG→ Inspection completed!

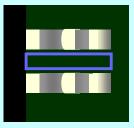
Step2: Black/white at the Pad If the dark area is 35% or less, OK



#### **Distribution**

Check brightness unevenness within the window.

= Effective for bridge inspection





ex., sample value=45

sample value=238

#### Example

Kind Bridge

**Lighting** Side/Low light (Select Low to reduce flux influence)

<OK Range>

Upper 80 Lower 0

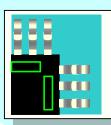
#### Point

Software calculation:

Step 1: Range (=Max-Min) calculation along the long-way direction Step 2: Pick up the minimum value (⇒ Sample value)

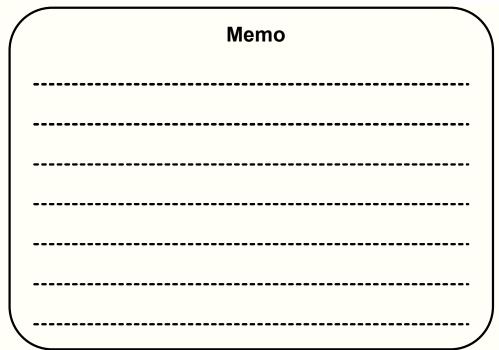
= When the bright material cross across the shorter direction of the window, the sample value will rise.

When it doesn't cross, the sample value will not rise.

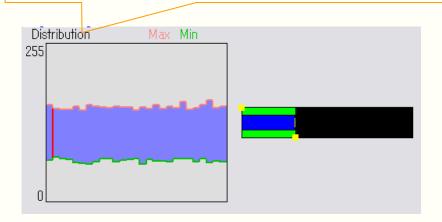


Application:

Distribution can be used for shift inspection.



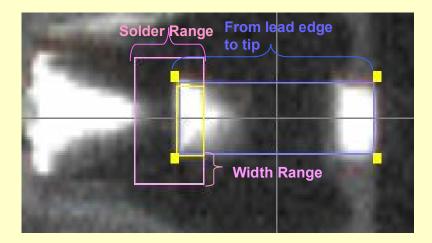
- Chart shows the Range calculation result (Max-Min)
- Red line shows the point where the sample value is extracted.





#### PinSolder/ASPinSolder

Automatically search the lead, and then check black/white within U-shaped Window.



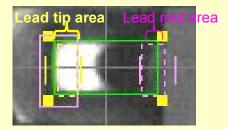
#### Solder Brightness 100

\* Equivalent to Level1 of "Black/white". Level2 is omitted

LeadWtrack 5 or 10 (auto-search the lead - shorter direction)

<OK Range> Black/white within U-shaped Window

 $\binom{100}{60}$ 

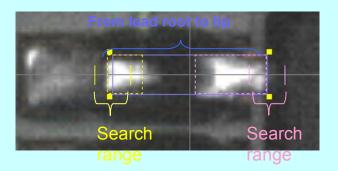


#### Merit

- Highly reliable inspection using auto-search, when lead has a good contrast
- Side fillet can be check by U-shaped Window (=mask is unnecessary)

#### **AS Lead Length**

Judge by lead length



For lifted lead, the lead length will be shorter or longer than the normal value.

Sample Measured length (Unit: dot)

<OK Range>

Allowable range for lead length (Normally, +/-20 for sample value)

	Memo		

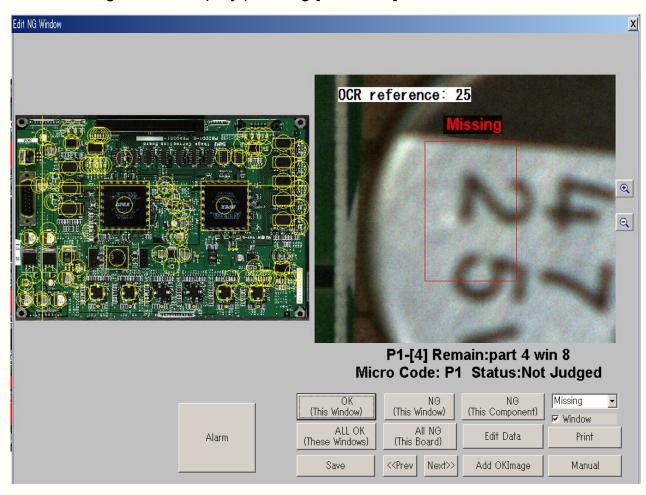


## Debug operation

#### DEBUG mode screen

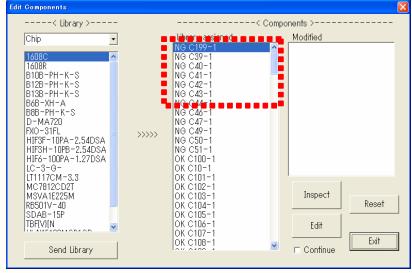
Select "Auto(A)"  $\rightarrow$  "Edit NG data".

Edit dialog will show up by pressing [Edit Data] button.



## ■ "Edit"→"Edit NG" or Keyboard "N"

Double-click on each component to edit inspection data.





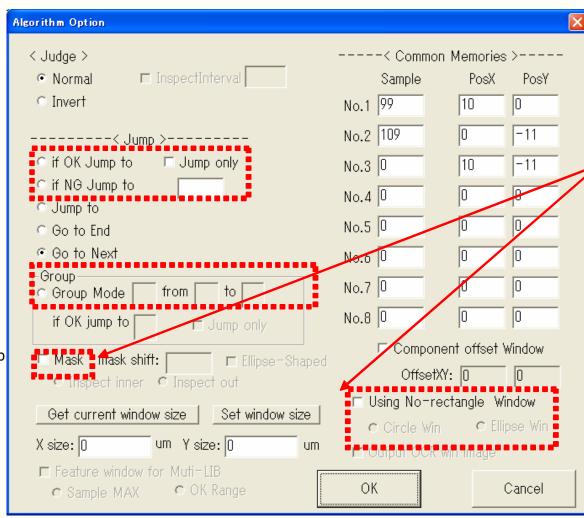
## Optional setting

#### OK jump function

Ex. If any one of 3 NewASC inspection is successful, jump to #005 inspection.

Normal OKJump	5 JOnly
0001: Area (	0)
0002: Adjust (	
0003: Adjust (	0) OK
0004: Adjust (	0)
0005: Missing (	0)
0006: NoSolder	( 0)
0007: NoSolder	( 0)
0008: Dryjoint(	0)
0009: Dryjoint(	0)
0010: Dryjoint(	0)

 When you want to reset OK jump Setting, tick "Go to Next".



#### Using MASK

SQ and Circular mask windows are available.



\* When double-clicking "Using MASK" in the upper right of the Image, mask becomes editable. (=Editing MASK)

#### Group mode

Ex. If two inspections are OK out of 5, 6, and 7, jump to 8

→ 2 5 to 7 8

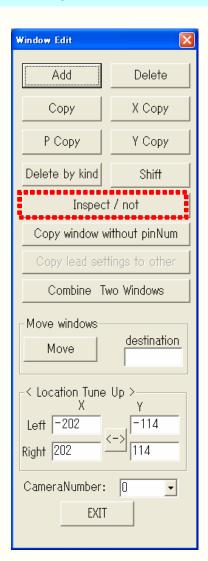


## "Skip inspection"

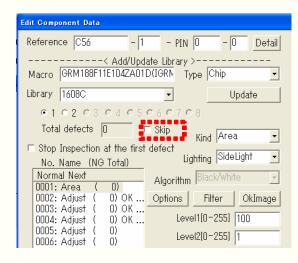
#### Inspection item

Right click on inspection item →Click "Inspect / not" When you want to RESET:

Right click on the inspection item again→Click "Inspect / not" again



Tick "Skip" on the Edit dialog RESET→Un-check "Skip"





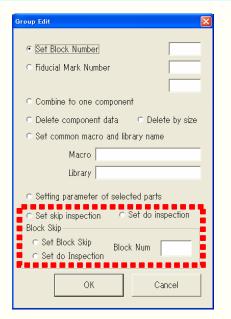
•Not-inspected component is are displayed in green dotted line.

#### Selected area

Drag a mouse to select components Display "Group Edit" dialog and tick "Set skip inspection". RESET→ Tick "Set do inspection"

#### Sub-board / Panel

Tick "Set Block Skip" and specify block#. RESET→ Tick "Set do inspection" in Block Skip window.



#### **■ Block Number assignment**

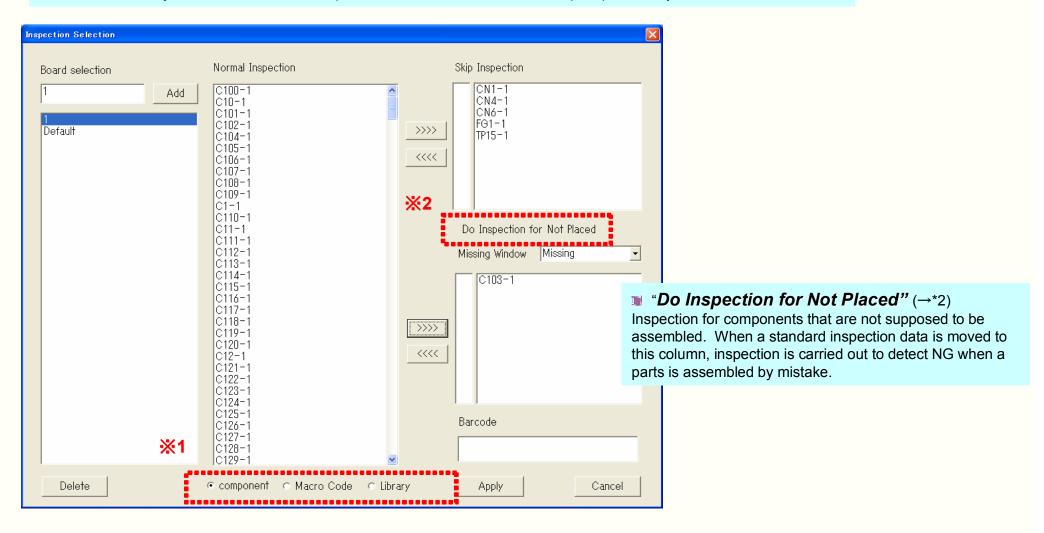
Drag a mouse to select entire panel. Display "Group Edit" dialog and tick Set Block Number, assigning a specific Number.



## Multiple Settings for same PCB

#### Component / Library / Macro

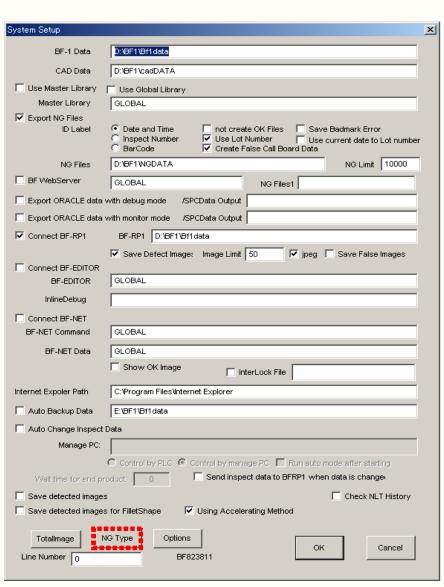
- 1. Control + Alt + "I" → Below edit dialog will be displayed
- 2. Add a new board name ex. 1 (Default=current board)
- 2. Select "Component / Macro Code or Library" (→\*1)
- 3. Select a subject item from "Normal inspection" window, and move it to "Skip Inspection" by ">>>".





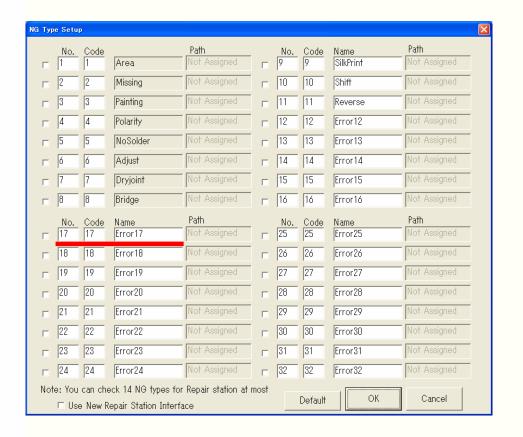
## Edit NG Type

#### Name of NG type can be customized.



#### Procedures

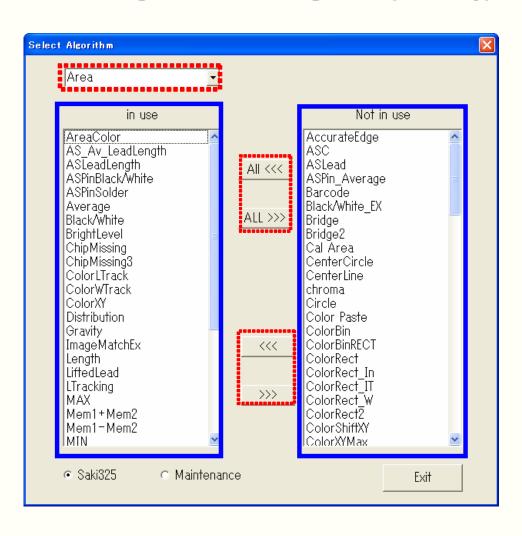
- 1. Select "Edit"→"System Setup" →"System Setting"→"NG Type"
- 2. "NG Type Setup" window will be displayed. "Error XX" parts are all user-definable.





## Edit Algorithm

#### A list of Algorithm can be organized per NG type.



#### Procedures

#### 1. $Ctrl + Alt + A \rightarrow$

"Select Algorithm" edit dialog will be displayed.

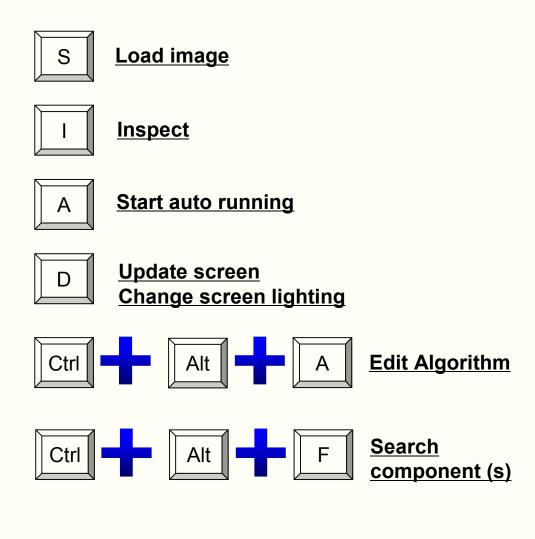
- \* Algorithm "in use" and hidden algorithm ("Not in use") are shown.
- 2-1. Select algorithm you wish to use from "Not in use" column

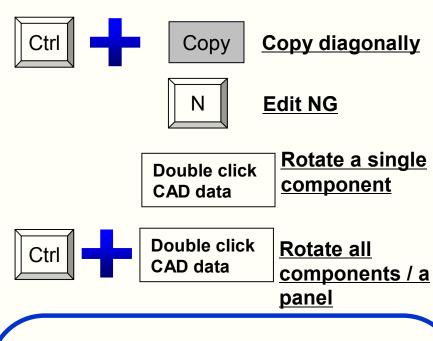
  →Click "<<" to move the algorithm to "in use" column.
- 2-2. The other way around, Select algorithm you don't need from " in use" column → Click ">>>" to move the algorithm to "Not in use"
- \* Setting needs to be modified per NG type.

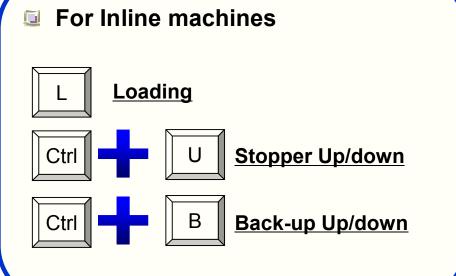
  If you want to reflect the change to all NG types, use "All<<<"or "ALL>>>".



## Useful Shortcut keys







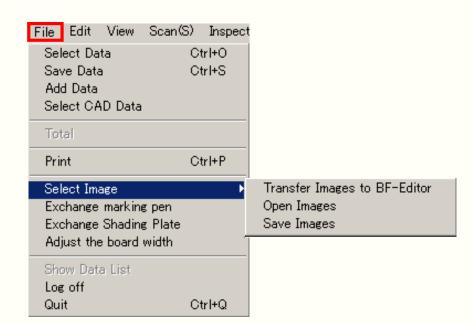


## System Functions / Toolbar

• [File]	P60	
• [Edit]	P61	
Search		
Add	P63	
Input Mode	P64	
Delete	P65	
Edit NG	P66	
Edit Library	P67-68	
• [View]	P69	
• [Inspect, Help]P70		



## Toolbar [File]





I. Select Data

Open inspection data

2. Save Data

Save inspection data

3. Add Data

Combine two separate data

(ex. combine Chip data and IC data that are separately generated)

 Select CAD Data Import CAD data.

Select Image

"Transfer Images to BF-Editor" = transfer the image and data from main system to BF-Editor.

- " Open Images" = Open saved image data.
- " Save Images" = Save image.
- 6. Quit

Exit BF software

#### Point



Image File

1,At main systems, scanned image should not be saved during regular operation.

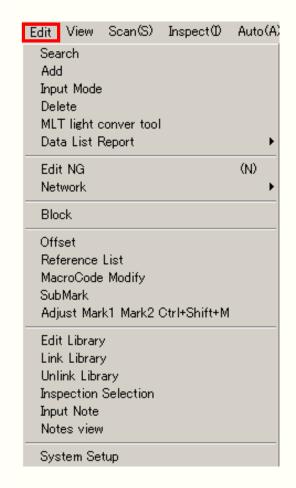
2.An image file name must be kept always as "TOPLIGHT.bmp"

Please save TOPLIGHT.bmp in a separate PCB folder in order to distinguish each image without changing the file name.

(BF system can recognize the image only saved as TOPLIGHT.)



## Toolbar [Edit]





1. Search

Data can be searched from various perspectives. (ex. Undefined, Chip, IC/Connector, Inspection Library, System data, etc.)

2. Add

Data can be added even without CAD data coordinate.

3. Input Mode

A data can be consecutively pasted like copying.

4. Delete

Delete data by various perspectives.

5. Block

Copy multiple panel data from original penal.

6. Offset

Move / reverse / rotate CAD data

7. Sub-mark

Check and change sub-mark coordinate

8. Adjust Mark1 Mark2

Data can be rotated or moved to XY axis direction, per fiducial mark.

◆ Select [Edit]→[Adjust Mark1Mark2], then adjust shifted data.

Shift amount can be adjusted by value.

Use either "Rotate mark1" or "Move mark1 and mark2"

9. Edit Library

Copy existing inspection library data between different data groups.

10. Link Library

Link latest libraries to all components

11. Unlink Library

Display an original CAD data

12. System Setup

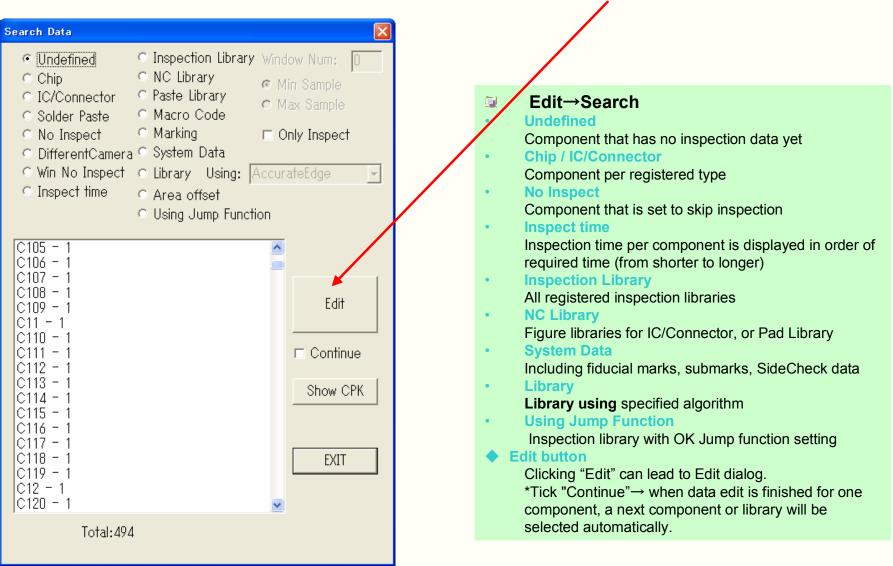
Open system setting dialog for various system set-up





## Search

Data can be searched based on the various categories. [Edit] button will lead to Edit dialog.



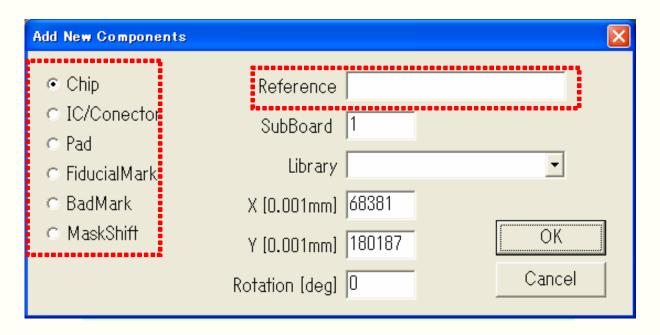
<sup>\* &</sup>quot;-1" of the above "component name-1" means sub-board/panel number.





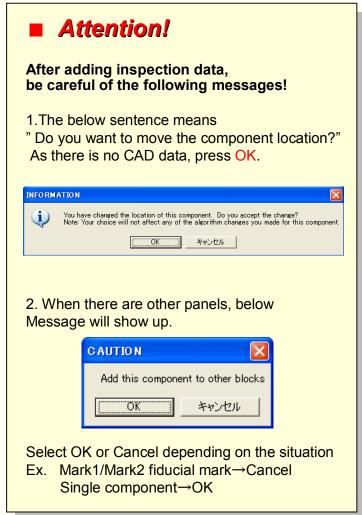


#### Data can be added freely even though there is no CAD data.



#### Procedures

- Click a location where you want to add an inspection data. Select "Edit" →"Add" "Add New Components" dialog will show up.
- 2. Select a type of component
- 3. Type in a reference.
- 4. Select an appropriate library if it has been registered already
- 5. Click OK to edit the date as usual.







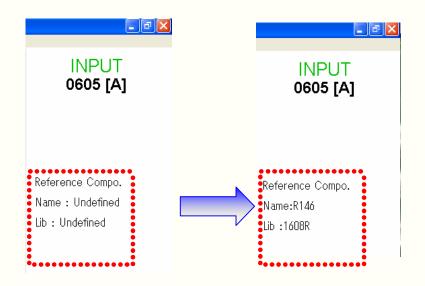
## Input Mode

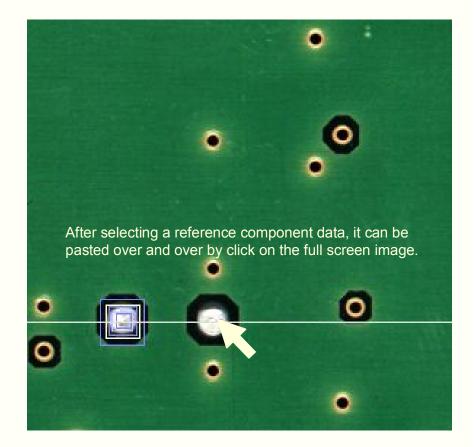
#### A selected inspection data can be pasted easily by mouse click.

\* Useful for component inspection without CAD data such as DIP pad solder inspection.

# Procedures Select "Edit"→"Input Mode". ("INPUT" is displayed on the screen) Right-click a component to copy. Open its edit dialog once and close. ("Name" and "Lib" are referred on screen index) When clicking a place where you want to paste the data,

the data will be pasted.





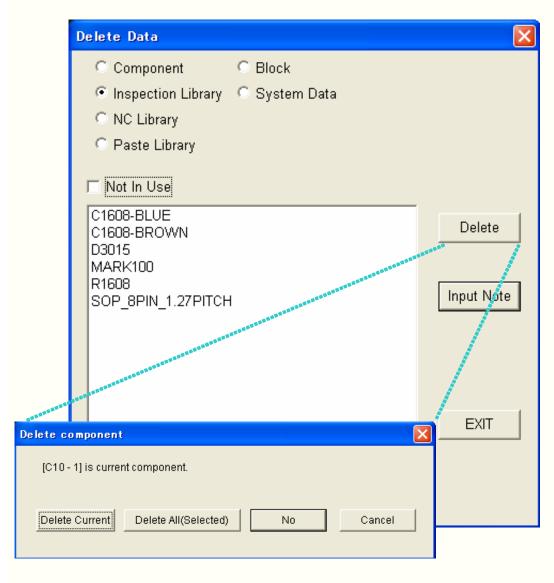
64





## Delete

#### **Delete data from various perspectives**



#### Components

All existing components data on PCB (both CAD data and inspection data)

Inspection library

All inspection data in use (Chip/IC/Connector)

NC library

IC library data in use (Only IC/Connectors)

• Paste library

Pad library in use

Block

Panel data

System data

Fiducial mark, Sub-mark, Side-Check, board data

Not in Use

Library data that are not used

#### **♦** Input Note

\*\*All data modification history can be put (ex. Who has deleted the data, date, reason....)



#### **■ Cautions!**

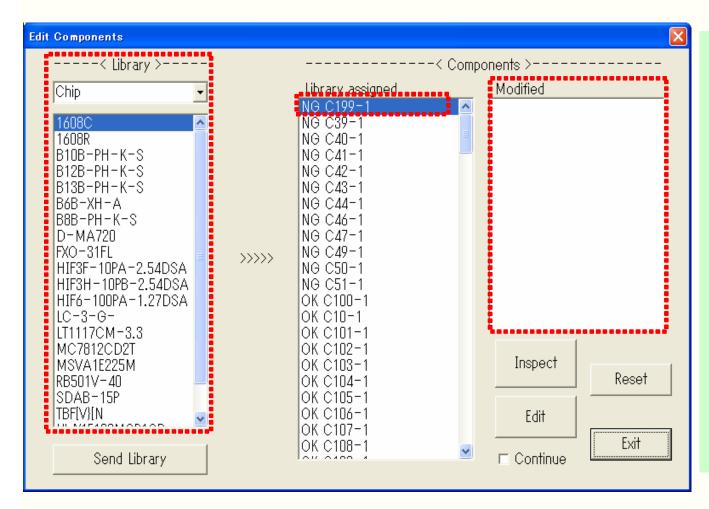
When deleting some inspection library data, please do the same For NC library in case of IC/Connector/Pad data.







#### NG component data can be displayed on the top of the list.



# "Edit"→"Edit NG" (=Shortcut key "N")

- 1. Select a component type to list up library data.
- 2. Select subject library to edit.
- 3. Under "Library assigned", components sharing the selected library will be displayed. NG components are displayed on the top.
- 4. Double click a NG component, or click "Edit" to open its edit dialog.
- 5. Edit data as usual.

#### Modified

When you do NOT "update" library data after data edit, that individual data will move to "modified" column.

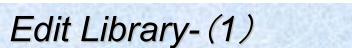
If you wish to update the data including that individual data, click "Reset"



#### **■** Point

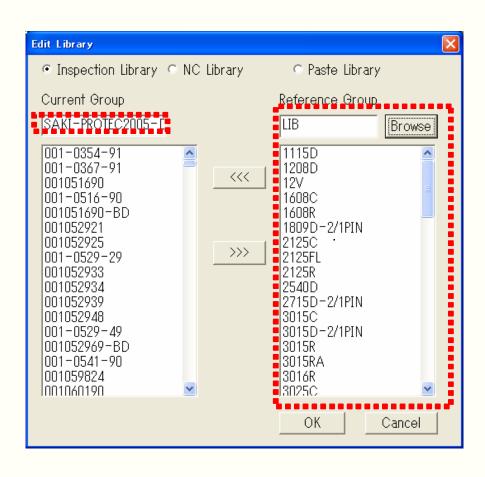
Modified component can be used when changing only one component data out of the group of the specified components temporarily. If you want to change the inspection setting eventually, please change the library name.







#### Existing inspection libraries can be copied between the different data groups.





#### **Procedures**

- Select "Edit"→"Edit Library" to open the Edit Library window.
- 2. Click "Browse" and select the data group to be copied.→Inspection library detail is displayed in the right Box.
- 3. Select the library to be copied and copy it to the **current group** by "<<<".

Data can also be copied to the Reference Group using ">>>" based on the Current Group.

#### **Point**

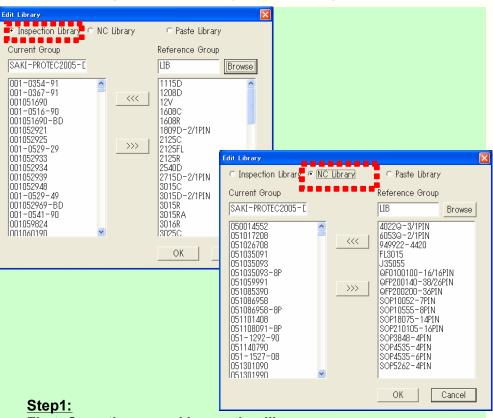
Library editing operation is just copying operation. So the original data will not be deleted nor moved.



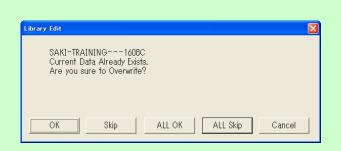


## Edit Library - (2)

#### Point1:Inspection Library+NC Library



#### Point 2:Data overwrite



When the same library exists in the copied folder, the above confirmation window for overwrite will be displayed.

When you want to update all based on the referenced data, Press "ALL OK" button to overwrite them all.

First, Copy the normal inspection library

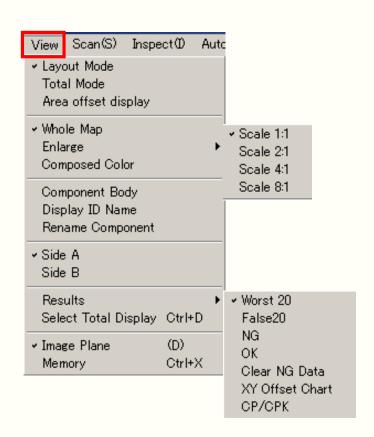
#### Step2:

Make sure to repeat the same for NC library.

Copying libraries for IC/connector/pad data can be completed only by taking these 2 steps.



## Toolbar (View)

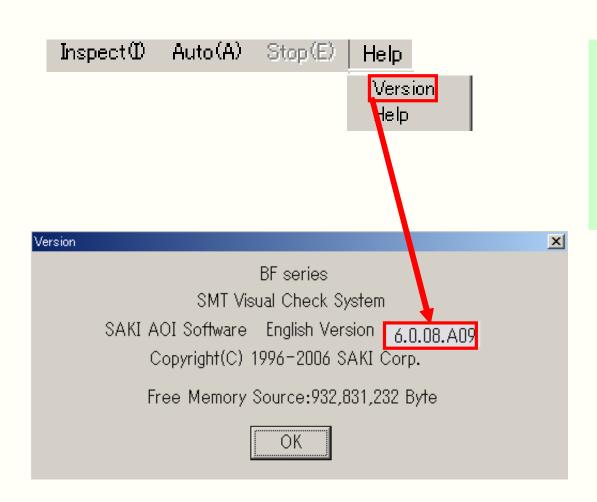




- 1. Layout Mode
  - Display the board image.
- 2. Total Mode
  - Display the total result in graph.
- 3. Enlarge
  - Change the display size on the screen.
- 4. Component Body
  - Only the "Area" window is displayed.
- 5. Display ID Name
  - Component name and reference are displayed.
- 6. Rename Component
  - Editing the component name can be done on the image.
  - ◆[View]→[Rename Component]→right-click the component center→rename the component
- 7. Side A, Side B
  - For double-sided boards, data can be switched between Side A and B.
- 8. Results
  - Configure the display setting of the inspection result.



# Toolbar [Inspect, Help]





1. Start the inspection.

NG components will be displayed in red.

\* Inspection also can be started by using keyboard "I".

Help

1. Version

Software version can be confirmed.

2. Help

Display the Programming Manual.